

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4256794

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HITACHI METALS NEOMATERIAL, LTD.	01/25/2017
RECEIVING PARTY DATA	
Name:	HITACHI METALS, LTD.
Street Address:	2-70, KONAN 1-CHOME
City:	MINATO-KU, TOKYO
State/Country:	JAPAN
Postal Code:	108-8224
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15248428
CORRESPONDENCE DATA	
Fax Number:	(202)822-1111
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	patentmail@whda.com
Correspondent Name:	WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP
Address Line 1:	1250 CONNECTICUT AVE., NW
Address Line 2:	SUITE 700
Address Line 4:	WASHINGTON, D.C. 20036
ATTORNEY DOCKET NUMBER:	P160791US00
NAME OF SUBMITTER:	SADAO KINASHI
SIGNATURE:	/Sadao Kinashi/
DATE SIGNED:	02/02/2017
Total Attachments: 1	
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ASSIGNMENT

WHEREAS, HITACHI METALS NEOMATERIAL, LTD. and a corporation duly organized under the laws of Japan and having its principal place of business at 2-19-1 Minami-Suita, Suita-shi, Osaka 564-0043, Japan and HITACHI METALS, LTD., a corporation duly organized under the laws of Japan and having its principal place of business at 2-70, Konan 1-chome, Minato-Ku, Tokyo, Japan 108-8224 are the owners of the entire right, title and interest in the invention entitled "LEAD MATERIAL FOR BATTERY AND METHOD FOR MANUFACTURING LEAD MATERIAL FOR BATTERY", which is described and claimed in U.S. Patent Application No. 15/248,428, by virtue of an assignment recorded at the U.S. Patent and Trademark Office on August 8, 2016, at Reel 039556, Frame 0083;

WHEREAS, HITACHI METALS NEOMATERIAL, LTD., hereinafter referred to as ASSIGNOR, is desirous of assigning its entire right, title and interest in said U.S. Patent Application;

WHEREAS, HITACHI METALS, LTD., hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest as held by ASSIGNOR in, to and under the said U.S. Patent Application;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: be it known that for good and valuable consideration, the adequacy and receipt of which is hereby acknowledged by ASSIGNOR, ASSIGNOR hereby sells, assigns, and transfers to ASSIGNEE, its entire right, title, and interest in and to United States Patent Application No. 15/248,428 and the inventions therein, for the full term of the said United States Patent Application and any and all U.S. patents granted therein and any reissue, extension, reexamination, continuation, or divisional thereof.

IN WITNESS WHEREOF, the undersigned ASSIGNOR has hereunto set hand and seal this 25th day of January, 2017.

Assignor: Hitachi Metals Neomaterial, Ltd.

Signature of Representative: Kenji Hirano
Name: Kenji HIRANO
Title: President